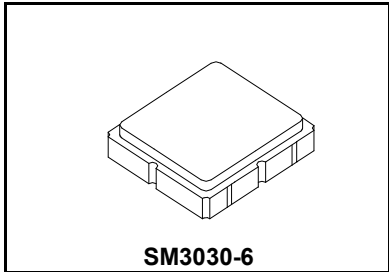


- Steep Roll-off Filter for 869.00 MHz Unlicensed Band
- Complies with Directive 2002/95/EC (RoHS)
- No Matching Required for Operation in 50Ω Environment
- Moisture Sensitivity Level: 1



**SF2137E**

**869.00 MHz  
SAW Filter**



**Absolute Maximum Ratings**

Rating	Value	Units
Input Power Level	17	dBm
DC Voltage on any Non-ground Terminal	3	V
Operating Temperature Range	-40 to +85	°C
Storage Temperature Range in Tape and Reel	-40 to +85	°C
Maximum Soldering Profile, 5 Cycles/10 seconds Maximum	265	°C

**Electrical Characteristics**

Characteristic	Sym	Notes	Min	Typ	Max	Units
Center Frequency	$f_c$			869.00		MHz
Bandwidth, 1 dB				11		
Bandwidth, 3 dB				17		
Insertion Loss, 868 to 870 MHz	IL			2.8	4.0	dB
Amplitude Ripple, 868 to 870 MHz				0.2	1.5	dB <sub>P-P</sub>
Attenuation Referenced to 0 dB:						dB
825 to 828 MHz			40	47		
835 to 842 MHz			30	39		
891 to 894 MHz			30	42		
910 to 913 MHz			40	47		
Source Impedance	$Z_s$			50		Ω
Load Impedance	$Z_L$			50		Ω

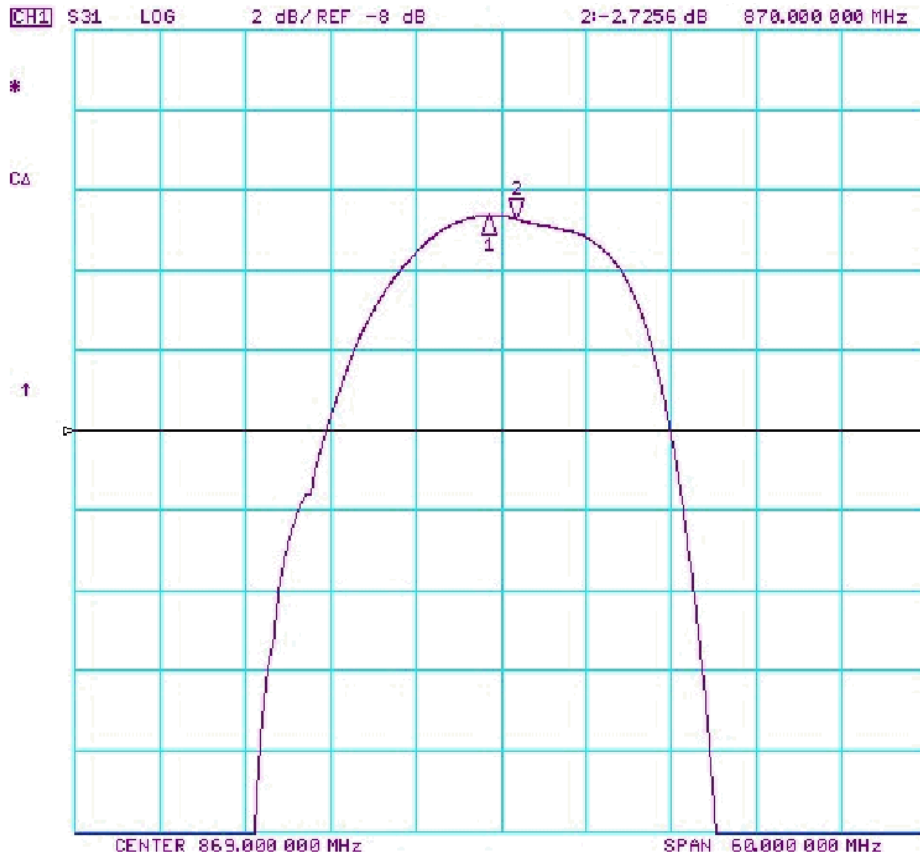
Case Style	SM3030-6 3.0 x 3.0 mm Nominal Footprint	
Lid Symbolization, Y=year, WW=week, S=shift, Dot=pin 1 indicator	711, <u>YWWS</u>	
Standard Reel Quantity	Reel Size 7 Inch	500 Pieces/Reel
	Reel Size 13 Inch	3000 Pieces/Reel

**Electrical Connections**

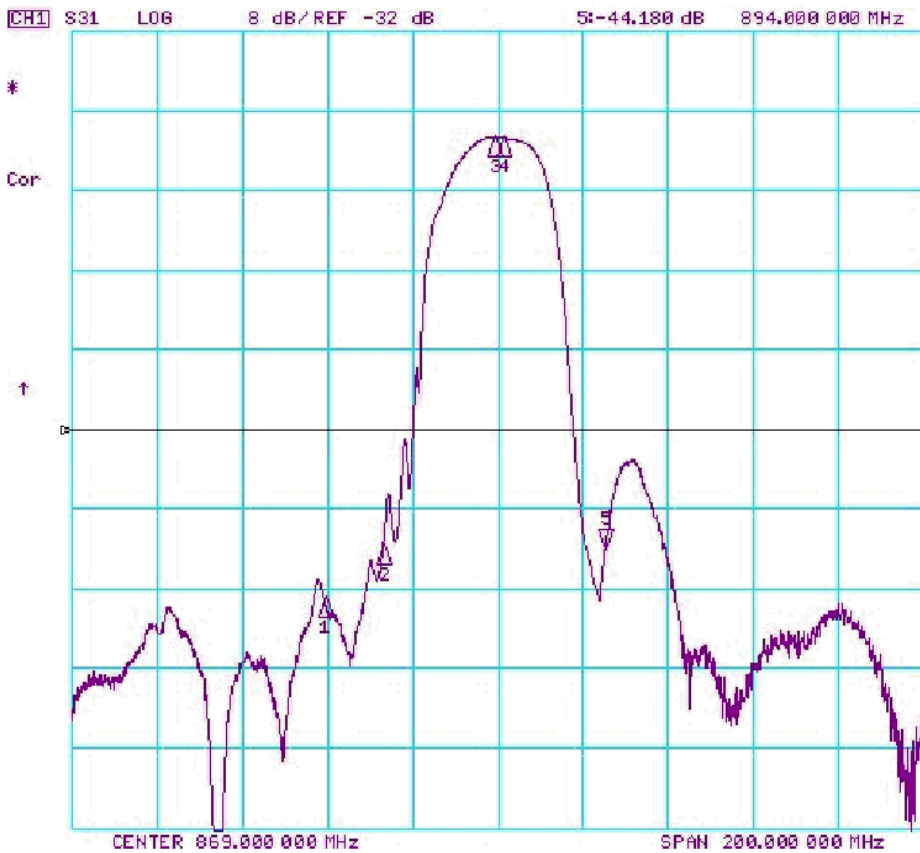
Connection	Terminals
Port 1	2
Port 2	5
Case Ground	All others

**CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.**  
**NOTES:**

1. The design, manufacturing process, and specifications of this device are subject to change.
2. US or International patents may apply.
3. RoHS compliant from the first date of manufacture.

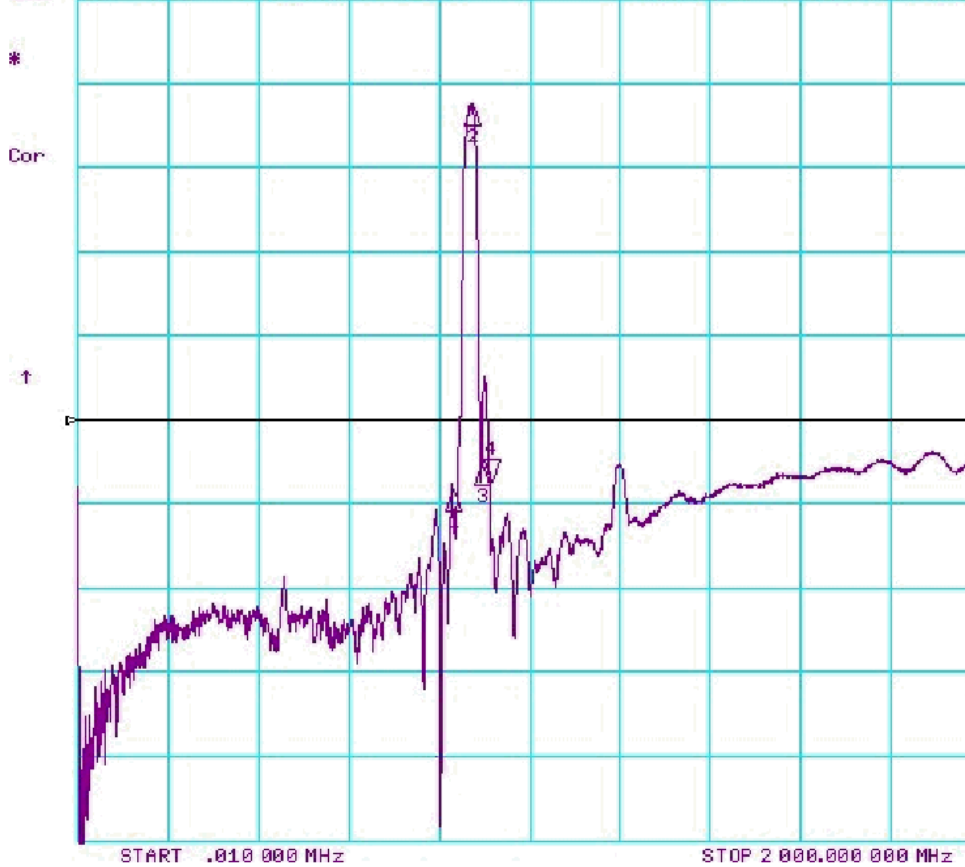


CH1 Markers  
 1i-2.6412 dB  
 868.000 MHz



CH1 Markers  
 1i-43.024 dB  
 828.000 MHz  
 2i-43.517 dB  
 842.000 MHz  
 3i-2.6378 dB  
 868.000 MHz  
 4i-2.7213 dB  
 870.000 MHz

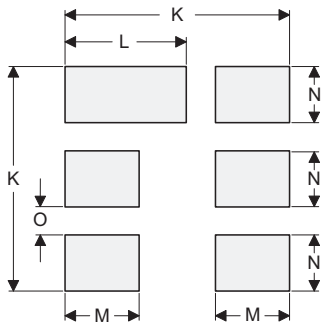
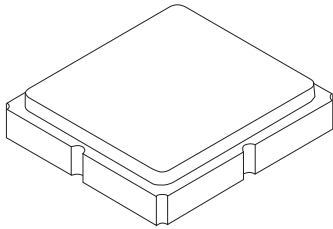
CH1 S31 LOG 10 dB/REF -40 dB 41-47.219 dB 910.000 000 MHz



CH1 Markers  
1:-48.523 dB  
820.000 MHz  
2:-2.5911 dB  
869.000 MHz  
3:-45.496 dB  
891.000 MHz

# SM3030-6 Case

## 6-Terminal Ceramic Surface-Mount Case 3.0 X 3.0 mm Nominal Footprint



PCB Footprint Top View

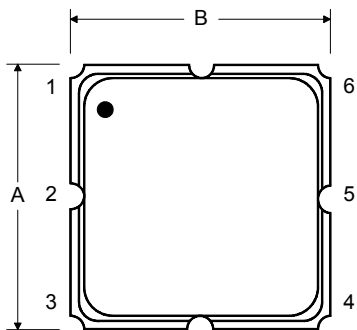
### Case and PCB Footprint Dimensions

Dimension	mm			Inches		
	Min	Nom	Max	Min	Nom	Max
A	2.87	3.00	3.13	0.113	0.118	0.123
B	2.87	3.00	3.13	0.113	0.118	0.123
C	1.12	1.25	1.38	0.044	0.049	0.054
D	0.77	0.90	1.03	0.030	0.035	0.040
E	2.67	2.80	2.93	0.105	0.110	0.115
F	1.47	1.60	1.73	0.058	0.063	0.068
G	0.72	0.85	0.98	0.028	0.033	0.038
H	1.37	1.50	1.63	0.054	0.059	0.064
I	0.47	0.60	0.73	0.019	0.024	0.029
J	1.17	1.30	1.43	0.046	0.051	0.056
K		3.20			0.126	
L		1.70			0.067	
M		1.05			0.041	
N		0.81			0.032	
O		0.38			0.015	

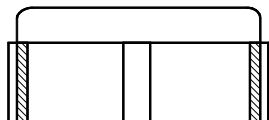
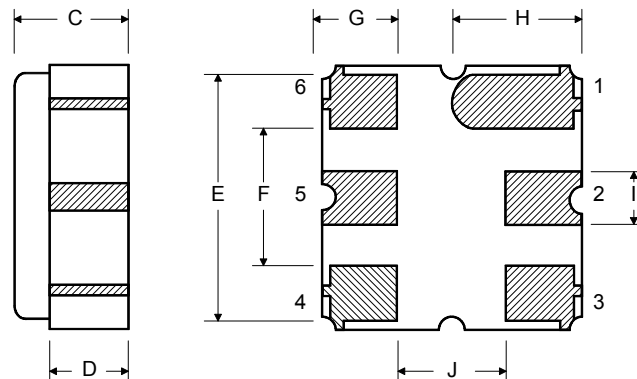
### Case Materials

Materials	
Solder Pad Plating	0.3 to 1.0 $\mu\text{m}$ Gold over 1.27 to 8.89 $\mu\text{m}$ Nickel
Lid Plating	2.0 to 3.0 $\mu\text{m}$ Nickel
Body	$\text{Al}_2\text{O}_3$ Ceramic
Pb Free	

### Top View

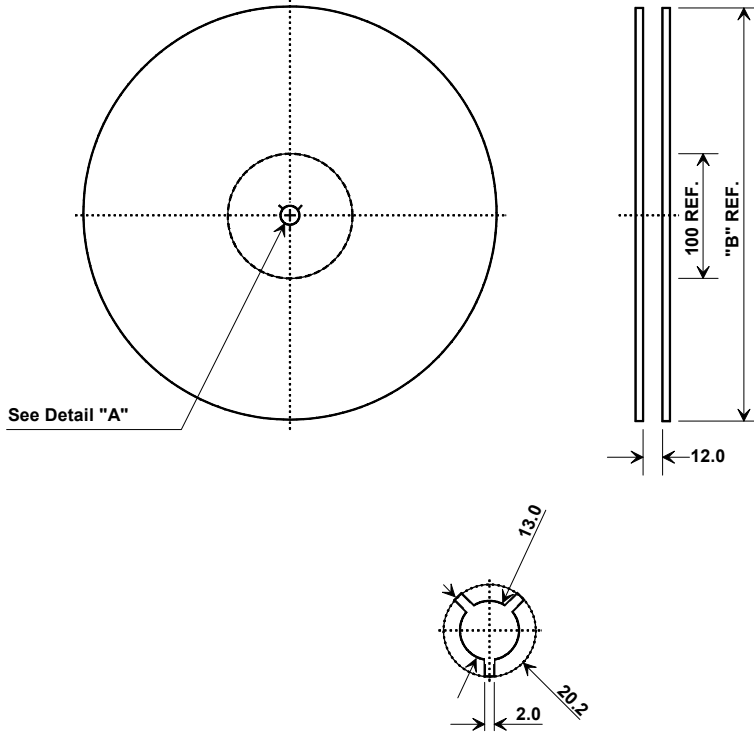


### Bottom View



## Tape and Reel Specifications

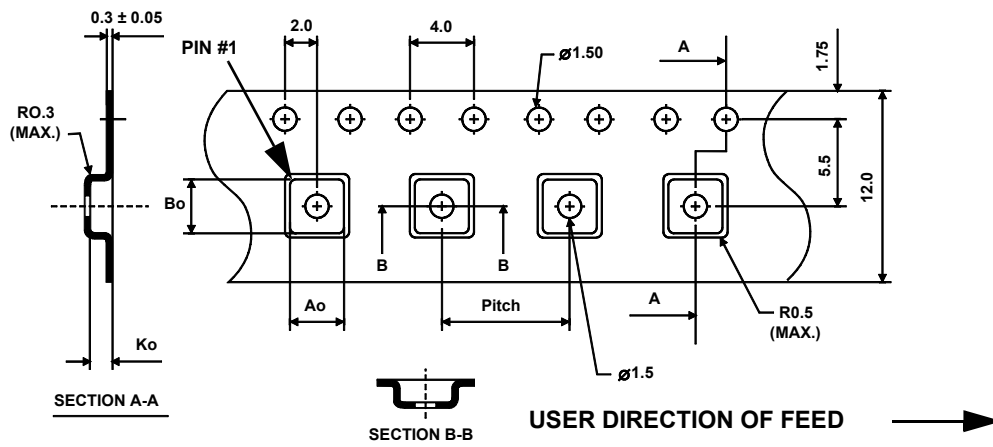
Tape and Reel Standard per ANSI/EIA-481



"B"		Quantity Per Reel
Inches	millimeters	
7	178	500
13	330	3000

### COMPONENT ORIENTATION and DIMENSIONS

Carrier Tape Dimensions	
Ao	3.35 mm
Bo	3.35 mm
Ko	1.40 mm
Pitch	8.0 mm
W	12.0 mm



## Recommended Reflow Profile

1. Preheating shall be fixed at 150~180°C for 60~90 seconds.
2. Ascending time to preheating temperature 150°C shall be 30 seconds min.
3. Heating shall be fixed at 220°C for 50~80 seconds and at 260°C +0/-5°C peak (10 seconds).
4. Time: 5 times maximum.

